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Thermal self-oscillations in radiative heat exchange

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We report the effect of relaxation-type self-induced temperature oscillations in the system of two parallel plates of SiO₂ and VO₂ which exchange heat by thermal radiation in vacuum. The nonlinear feedback in the self-oscillating system is provided by metal-insulator transition in VO₂. Using the method of fluctuational electrodynamics, we show that under the action of an external laser of a constant power, the temperature of VO₂ plate oscillates around its phase transition value. The period and amplitude of oscillations depend on the geometry of the structure. We found that at 500 nm vacuum gap separating bulk SiO₂ plate and 50 nm thick VO₂ plate, the period of self-oscillations is 2 s and the amplitude is 4 K, which is determined by phase switching at threshold temperatures of phase transition. © 2015 AIP Publishing LLC. [http://dx.doi.org/10.1063/1.4908188]

A self-oscillation is undamped oscillation in dynamical system with non-linear feedback under the action of timeconstant non-periodical external power source. The distinction of self-oscillations from forced oscillation is that the latter is driven by a source of power that is modulated externally. The examples of self-oscillations are such natural phenomena as vibration of the plant leaves under the influence of a uniform air flow, formation of turbulent water flows in the river shallows, the voices of humans, animals, and birds, and heartbeat.¹ The amplitude and waveform of self-oscillations are determined by nonlinear characteristics of the system. Two types of self-oscillations are commonly distinguished: harmonic-type and relaxation-type. In case of harmonic-type self-oscillation, the oscillatory system is capable for natural damping vibration on a resonance frequency. The shape of the waveform is close to sinusoidal. The relaxation-type selfoscillations have no resonant frequency. The actual period of oscillation depends on the switching at the thresholds, which fix the amplitude. The waveform of this type of selfoscillation may be very different from sinusoid.

A large variety of devices are based on electrical selfoscillations. Among them are integrated a.c. signal generators, inverters, and pressure and temperature sensors. The generation of electrical self-oscillations in devices which are based on VO₂ was demonstrated in Refs. 2–7. The physical origin of self-oscillation in Refs. 2-7 is the Mott-like phase transition in VO₂ at $T_{ph} = 340 \text{ K.}^8$ When the temperature of VO_2 is smaller than T_{ph} , then it behaves as a uniaxial crystal with the optical axis orthogonal to its interfaces. On the other hand, when the temperature of VO₂ is higher than T_{ph} , a VO₂ plate is in its metallic phase and remains in this state for higher temperatures.^{9,10} The formation of the metallic phase occurs within ~ 200 fs.¹¹ Due to the phase transition, the current-voltage characteristics of VO2-based devices possesses a negative differential resistance region that allows generating electrical self-oscillations.²⁻⁷ Recently, it was shown that VO_2 can be applied to the creation of thermal analog of such electronic components as transistor,¹² diode,¹³ and memory.^{14–16} In the above thermal devices, the electric current is replaced by a radiative heat flow, where the thermal photons play a role of heat transfer carriers.

In the present work, we report the thermal analog of electrical self-oscillations in VO₂-based device. Thermal self-oscillations can be potentially interesting for practical realization of devices based on radiative heat flux control. A sketch of the self-oscillating system is shown in Fig. 1. The structure consists of two parallel plates of SiO₂ and VO₂ which exchange thermal radiation through vacuum gap. We exclude such ways of heat transfer as convection and heat conduction via phonons and electrons. The choice of SiO₂ as a material of the first plate is based on a strong coupling between the SiO₂ and VO₂ surface-phonon polaritons. The system is immersed in a thermal bath at temperature of $T_{bath} = 300$ K. We assume that the temperature of SiO₂ plate is fixed at 340 K, while the temperature of VO₂ is varied. The system is exposed by an external light source of constant



FIG. 1. The self-oscillating system consisting of bulk SiO_2 plate and thin VO_2 plate separated by a vacuum gap. The VO_2 plate is illuminated by an external laser of a constant power.

power. We will show that at a certain power of the external light source, the metal-insulator phase transition in VO_2 plays a role of positive non-linear feedback that ensures the self-induced oscillations of the temperature of VO_2 plate.

The temporal dynamics of VO₂ plate due the radiataive heat exchange with SiO_2 plate is described in terms of the standard energy balance equation^{17–19}

$$\rho c_v d \frac{dT_2(t)}{dt} = F_{ext}(T_2) + F_{int}(T_2) + F_{bath}(T_2), \quad (1)$$

where $\rho c_v d$ is thermal inertia of VO₂ plate, with the mass density $\rho = 4.6 \text{ g/cm}^3$, the mass heat capacitance at constant volume c_v , and the thickness of VO₂ plate *d*. In calculations, the temperature dependence of the mass heat capacitance of VO₂ is accounted for by the Debye model with Debye temperature of 750 K, the molar mass of 85.92 g/mol, and the number of atoms in VO₂ molecule of 3. On the right-hand side of Eq. (1), the term F_{ext} is a portion of the external power which is absorbed in VO₂. F_{ext} is defined as aF_0 , where F_0 is the laser power and *a* is absorption coefficient of VO₂ plate. The parameter *a* can be calculated by the scattering matrix formalism.²⁰ The term F_{int} in Eq. (1) is the change of internal energy of VO₂ plate during the time *dt* due to the radiative heat exchange between plates

$$F_{int}(T_2) = F_{11}(T_2) - F_{12}(T_2) - F_{21}(T_2) - F_{22}(T_2), \quad (2)$$

where F_{ij} is the energy flux of thermal radiation of *i*-th plate in z_j coordinate as shown in Fig. 1. Indices i = 1 and 2 stand for SiO₂ and VO₂ plates correspondingly; z_1 denotes any coordinate in the separation gap and z_2 denotes any coordinate in the upper semi-infinite vacuum. The radiative heat transfer between plates is calculated with a fluctuation dissipation theorem.²¹ The energy fluxes F_{ij} are expressed as²²

$$F_{ij} = \sum_{s,p} \int_0^\infty \frac{d\omega}{2\pi} \Theta(\omega, T_i) \int_0^\infty \frac{k_x dk_x}{2\pi} f_{ij}(\omega, k_x), \qquad (3)$$

where ω is the angular frequency and k_x is the *x*-component of wavevector of thermal radiation from *i*-th plate, $f_{ij}(\omega, k_x)$ is the monochromatic flux of thermal radiation at certain k_x , $\Theta(\omega, T_i) = \hbar \omega / [\exp(\hbar \omega / k_B T_i)]$ is the mean energy of Planck oscillator, and k_B is Boltzmann's constant. Expression (2) accounts for contribution of both *s*- and *p*-polarizations. The monochromatic flux of thermal radiation $f_{ij}(\omega, k_x)$ is calculated using the complex amplitude reflectance and transmittance of the plates. For $k_x < \omega/c$, the coefficients $f_{ij}(\omega, k_x)$ are given by the following expressions:

$$f_{11} = (1 - |r_1|^2)(1 - |r_2|^2)|D|^{-2},$$
(4)

$$f_{21} = (1 - |r_1|^2)(1 - |r_2|^2 - |t_2|^2)|D|^{-2},$$
 (5)

$$f_{12} = (1 - |r_1|^2)|t_2|^2|D|^{-2},$$
(6)

$$f_{22} = 1 - |r_{02}|^2 - (1 - |r_1|^2)|t_2|^2 |D|^{-2},$$
(7)

where $D = 1 - r_1 r_2 e^{2ik_x 0h}$ is the Fabry-Perot like denominator and *h* is the separation distance. For $k_x > \omega/c$,

$$f_{11} = f_{21} = 4 \operatorname{Im}(r_1) \operatorname{Im}(r_2) e^{-2|k_{20}|h|} |D|^{-2},$$
(8)

$$f_{12} = f_{22} = 0.$$
 (9)

In expressions (4)–(9), r_i and t_i are the complex amplitude reflectance and transmittance of the *i*-th plate, r_{02} is the complex amplitude reflectance and transmittance of the whole structure from the side of VO₂ plate and k_{z0} is the *z*-component of the wavevector in vacuum. Parameters r_i and t_i can be calculated by means of the scattering matrix method.^{17,20,23} The Fresnel coefficients used in construction of the scattering matrices, accounting for anisotropy of VO₂ plate, are described in Refs. 13 and 24. Fanally, the term F_{bath} in Eq. (1) denotes the power which is absorbed in the VO₂ plate due to the thermal bath.

The metal-insulator transition of VO₂ is characterized by the hysteresis of optical constants and the latent heat which is absorbed in VO_2 during the phase transformations. In calculations, we assume that the phase transition occurs in the temperature range of $\{T_{ph} - \Delta T, T_{ph} + \Delta T\}$, where the heat capacitance equals to $c_v = c_{vo} + \Delta c_v$ as shown in Fig. 2(a). The term c_{vo} is the heat capacitance of VO₂ calculated by the Debye model while the term Δc_v has a meaning of an extra heat capacitance which is found from the expression for the latent heat: $L = 2\Delta c_v \Delta T$, where $\Delta T = 2$ K and $L = 51.49 \text{ J/g.}^9$ The hysteresis of optical constants is modeled by an elementary non-ideal relay which is represented by rectangular loops on the $T_2 - n$ and $T_2 - \kappa$ coordinate planes. See example of such loop in Fig. 2(b) for the extinction coefficient κ at $\omega = 150$ THz. Hence, the metal-insulator transition is described by two temperatures $T_{ph} \pm \Delta T$, which we call as threshold temperatures later on. As will be shown later, the presence of hysteresis is crucial for achieving selfoscillations.

The phase portrait of the metal insulator transition in d = 50 nm thick VO₂ plate which is separated from SiO₂ by h = 500 nm vacuum gap is shown in Fig. 3 as a dependence of the net power flux for VO₂ plate, $F_{net} \equiv F_{int} + F_{ext} + F_{bath}$, on the temperature T_2 for two different laser powers. The directions of temperature relaxations are determined by the sign of F_{net} and are shown in Fig. 3 by arrows. Both $F_{net}(T_2)$ dependences possess the hysteresis which consists of the jumps of net power flux F_{net} at the threshold temperatures $T_{ph} \pm \Delta T$ as well as of the relaxation regions between them. When $F_{ext} = 900 \text{ W/m}^2$, the phase trajectory meets the x-axis at 348.1 K. It means that the system termalizes to 348.1 K at the above external power flux. In the case $F_{ext} = 340 \text{ W/m}^2$, the directions of temperature relaxation are opposite in metallic and insulator phases which causes the periodic alterations



FIG. 2. Temperature dependence of the mass heat capacitance (a) and imaginary part of refractive index of VO₂ at $\omega = 150$ THz (b) near the phase transition temperature.



FIG. 3. The net power flux F_{net} for VO₂ plate as a function of its temperature, T_2 . The arrows show the directions of temperature and phase transformations on the phase trajectories. Solid (dashed) lines denotes the regions of the phase diagram where VO₂ is in its crystalline (metallic) state. Vacuum gap h = 50 nm, thickness of VO₂ plate d = 500 nm, laser power $F_0 = 340$ and 900 W/m².

of VO₂ plate temperature. Please note that in the simulations described above, we assume that the derivatives dn/dT_2 and $d\kappa/dT_2$ if not infinite, are large enough at $T_2 = T_{ph} \pm \Delta T$, which is a key factor causing the self-induced oscillations. Our additional simulations have shown that due to thermal inertia of VO₂ plate, the self-oscillations occur even if the parameters $n(T_2)$ and $\kappa(T_2)$ change not instantly but in a small temperature range $dT_2 < 1.6$ K around threshold values $T_{ph} \pm \Delta T$.

The jumps of net power flux F_{net} is essentially nonlinear process owing to the change of internal structure of VO_2 during the phase transition. Note that the oscillations occur under a time-constant external power flux. Thus, the considered alterations are relaxation-type self-oscillations of VO₂ plate temperature, where the metal-insulator phase transition plays a role of positive non-linear feedback. The oscillatory system never gets the stationary state but constantly thermalizes along its phase trajectories. The similar jumps of the net heat flux at the threshold temperatures were studied in Refs. 14, where $F_{net}(T_2)$ demonstrated the effect of negative differential thermal conductance from SiO_2 plate to VO_2 plate. Unlike in Ref. 14, in the present work, the thickness of plates and the separation distance between them were chosen in such a way that the dependence $F_{net}(T_2)$ is monotonically decreasing.

In order to explicitly demonstrate the self-oscillation of VO_2 temperature as well as to find its period, let us simulate the dynamics of the radiative heat exchange between the plates. We found the temporal dependencies of VO₂ temperature by solving the integro-differential equation (1) with initial condition $T_2(0) = 330$ K. Fig. 4 shows the time evolutions $T_2(t)$ obtained for different external power fluxes. In the case of absence of external power flux $(F_{ext} = 0)$, the VO2 temperature increases to 333 K without the phase transition. When $F_{ext} = 900 \text{ W/m}^2$, the VO₂ plate transits from insulator to metallic state and thermalizes to a constant temperature 348.1 K that corresponds to the intersection point between the phase trajectory and the x-axis in Fig. 3. In the time interval from 0 to $0.004 \,\mathrm{s}$, the temperature increases faster than in the subsequent interval from 0.004 s to 0.38 s. This is due to the fact that in temperature range of



FIG. 4. The time evolutions of VO₂ plate temperature at different external powers, F_{ext} . Solid (dashed) lines denotes the time intervals when VO₂ is in its crystalline (metallic) phase.

338–342 K, the energy which is absorbed in VO₂ plate is spent for the phase transition. Finally, in the case of 340 W/m² external power, the temperature T_2 starts to oscillate after 1 s relaxation to 342 K. The period of oscillation is about 2 s and is determined by the thermal inertia of VO₂ plate, separation distance between the plates, laser power, threshold temperatures, and latent heat of the phase transition. The temperature oscillations are accompanied by periodical switches between insulator and metallic states of VO₂.

We believe the discussed example of self-oscillation is interesting both from theoretical and practical viewpoints. The results not only reveal an interesting phenomenon in heat exchange among bodies involving phase-change materials but also suggest opportunities for application such as active thermal management and thermal information processing. The discussed oscillatory system is a theoretical prototype of a thermal oscillation generator.

In conclusion, we have theoretically demonstrated the effect of relaxation-type temperature self-oscillation in radiative heat exchange between VO₂ and SiO₂ plates in vacuum. The hysteresis of optical constants of VO₂ at threshold temperatures acts as non-linear feedback that supports the selfoscillations. The oscillation period is determined by relaxation characteristics of the system and the threshold temperatures. Generalization of the studied phenomenon to the phonon- or electron-mediated heat exchange between different parts of the system may reveal the potential for significant shortening of the oscillation period.

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